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PATENT

I hereby certify that on the date specified below, this correspondence is being deposited with the United States Postal Service as first-class mail in an envelope addressed to Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Date

March 24, 2006

Denise Sheridan

Denise Sheridan

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No. :	10/773,520	Confirmation No. :	6540
Applicant :	Joseph M. Jeddeloh		
Filed :	February 5, 2004	Attorney Docket No.:	33583/US
Art Unit :	2181	Customer No. :	27,076
Examiner :	Not yet assigned		
Title :	ARBITRATION SYSTEM HAVING A PACKET MEMORY AND METHOD FOR MEMORY RESPONSES IN A HUB-BASED MEMORY SYSTEM		

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In accordance with 37 C.F.R. §§ 1.56 and 1.97 through 1.98, applicant wishes to make known to the Patent and Trademark Office the references set forth on the attached form PTO-1449. Copies of the cited U.S. patents and U.S. patent application publications will not be submitted herewith in accordance with the waiver by the Office of the requirement under 37 C.F.R. § 1.98(a)(2)(i) for U.S. national patent applications filed after June 30, 2003. Although the aforesaid references are made known to the Patent and Trademark Office in compliance with applicant's duty to disclose all information he is aware of which is believed relevant to the examination of the above-identified application, applicant believes that his invention is patentable.

Applicant also wishes to make known to the Patent and Trademark Office that an application, Serial No. 11/274,857, describing and claiming subject matter that is similar to the

subject matter of this application, was filed on November 14, 2005. This related application, as well as any prior art cited therein, may be material to the examination of this application. A copy of this related application as filed is submitted herewith in accordance with 37 C.F.R. § 1.98(d).

Please acknowledge receipt of this Supplemental Information Disclosure Statement and kindly make the cited references of record in the above-identified application.

Respectfully submitted,

DORSEY & WHITNEY LLP



Edward W. Bulchis
Registration No. 26,847

EWB:sp

Enclosures:

- Postcard
- Form PTO-1449
- Copy of Related Application (1)

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FORM PTO-149
(REV.7-80)U.S. DEPARTMENT OF COMMERCE
PATENT AND TRADEMARK OFFICEATTY. DOCKET NO.
33583/USAPPLICATION NO.
10/773,520

INFORMATION DISCLOSURE STATEMENT

(Use several sheets if necessary)

APPLICANT(S)
Joseph M. JeddelohFILING DATE
February 5, 2004GROUP ART UNIT
2181

U.S. PATENT DOCUMENTS

*EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
AA	3,742,253	06/26/73	Kronies	307	247	
AB	4,608,702	08/26/86	Hirzel et al.	375	110	
AC	4,831,520	05/16/89	Rubinfeld et al.	364	200	
AD	4,891,808	01/02/90	Williams	370	112	
AE	5,313,590	05/17/94	Taylor	395	325	
AF	5,687,325	11/11/97	Chang	395	284	
AG	5,748,616	05/05/98	Riley	370	242	
AH	6,038,630	03/14/00	Foster et al.	710	132	
AI	6,067,649	05/23/00	Goodwin	714	718	
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AK	6,487,556 B1	11/26/02	Downs et al.	707	101	
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AM	6,904,556 B2	06/07/05	Walton et al.	714	766	
AN	6,910,109 B2	06/21/05	Holman et al.	711	156	
AO	6,947,672 B2	09/20/05	Jiang et al.	398	135	
AP	2003/0217223 A1	11/20/03	Nino, Jr., et al.	711	105	
AQ	2004/0034753 A1	02/19/04	Jeddeloh	711	163	
AR	2004/0128449 A1	07/01/04	Osborne et al.	711	137	
AS	2005/0166006 A1	07/28/05	Talbot et al.	711	105	

OTHER PRIOR ART (Including Author, Title, Date, Pertinent Pages, Etc.)

AT	
AU	

EXAMINER	DATE CONSIDERED

* EXAMINER: Initial if reference considered, whether or not criteria is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant(s).